

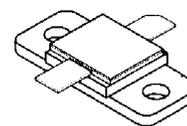
## The RF Line Microwave Long Pulse Power Transistor

Designed for 960–1215 MHz long or short pulse common base amplifier applications such as JTIDS and Mode-S transmitters.

- Guaranteed Performance @ 960 MHz, 36 Vdc  
Output Power = 30 Watts Peak  
Minimum Gain = 9.0 dB Min (9.5 dB Typ)
- 100% Tested for Load Mismatch at All Phase Angles with 10:1 VSWR
- Hermetically Sealed Industry Standard Package
- Silicon Nitride Passivated
- Gold Metallized, Emitter Ballasted for Long Life and Resistance to Metal Migration
- Internal Input Matching for Broadband Operation

**MRF10031**

**30 W (PEAK)  
960–1215 MHz  
MICROWAVE POWER  
TRANSISTOR  
NPN SILICON**



### MAXIMUM RATINGS

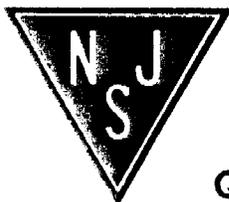
Rating	Symbol	Value	Unit
Collector–Emitter Voltage	$V_{CES}$	55	Vdc
Collector–Base Voltage (1)	$V_{CBO}$	55	Vdc
Emitter–Base Voltage	$V_{EBO}$	3.5	Vdc
Collector Current — Continuous (1)	$I_C$	3.0	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ (1), (2) Derate above $25^\circ\text{C}$	$P_D$	110 0.625	Watts mW/°C
Storage Temperature Range	$T_{stg}$	– 65 to + 200	°C
Junction Temperature	$T_J$	200	°C

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (3)	$R_{\theta JC}$	1.6	°C/W

#### NOTES:

1. Under pulse RF operating conditions.
2. These devices are designed for RF operation. The total device dissipation rating applies only when the devices are operated as pulsed RF amplifiers.
3. Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques. (Worst case  $\theta_{JC}$  value measured @ 23% duty cycle)



NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.

**Quality Semi-Conductors**

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted.)

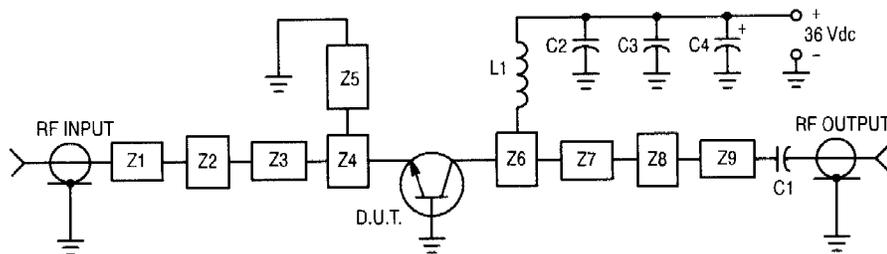
Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b>					
Collector-Emitter Breakdown Voltage ( $I_C = 25\text{ mAdc}$ , $V_{BE} = 0$ )	$V_{(BR)CES}$	55	—	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 25\text{ mAdc}$ , $I_E = 0$ )	$V_{(BR)CBO}$	55	—	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 5.0\text{ mAdc}$ , $I_C = 0$ )	$V_{(BR)EBO}$	3.5	—	—	Vdc
Collector Cutoff Current ( $V_{CB} = 36\text{ Vdc}$ , $I_E = 0$ )	$I_{CBO}$	—	—	2.0	mAdc

**ON CHARACTERISTICS**

DC Current Gain ( $I_C = 500\text{ mAdc}$ , $V_{CE} = 5.0\text{ Vdc}$ )	$h_{FE}$	20	—	—	—
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**FUNCTIONAL TESTS** (10  $\mu\text{s}$  Pulses @ 50% duty cycle for 3.5 ms; overall duty cycle - 25%)

Common-Base Amplifier Power Gain ( $V_{CC} = 36\text{ Vdc}$ , $P_{out} = 30\text{ W Peak}$ , $f = 960\text{ MHz}$ )	$G_{PB}$	9.0	9.5	—	dB
Collector Efficiency ( $V_{CC} = 36\text{ Vdc}$ , $P_{out} = 30\text{ W Peak}$ , $f = 960\text{ MHz}$ )	$\eta$	40	45	—	%
Load Mismatch ( $V_{CC} = 36\text{ Vdc}$ , $P_{out} = 30\text{ W Peak}$ , $f = 960\text{ MHz}$ , $VSWR = 10:1$ All Phase Angles)	$\psi$	No Degradation in Output Power			



- C1 — 75 pF 100 Mil Chip Capacitor
- C2 — 39 pF 100 Mil Chip Capacitor
- C3 — 0.1  $\mu\text{F}$
- C4 — 1000  $\mu\text{F}$ , 50 Vdc, Electrolytic
- L1 — 3 Turns #18 AWG, 1/8" ID, 0.18 Long

- Z1-Z9 — Microstrip. See Details
- Board Material — Teflon, Glass Laminate
- Dielectric Thickness = 0.030"
- $\epsilon_r = 2.55$ , 2 Oz. Copper

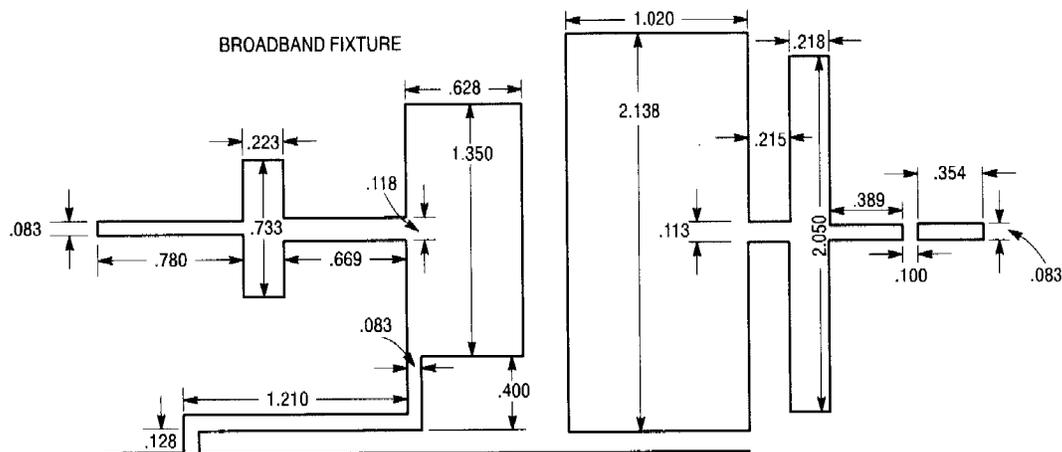


Figure 1. Test Circuit